



Product Change Notification

Change Notification #: 115123 - 00

**Change Title: Intel® Server Chassis
H2224XXKR2,
PCN 115123-00
Product Material, Label,
PSU Label Changes**

Date of Publication: November 25, 2016

Key Characteristics of the Change:

Product Material, Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	December 12, 2016
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

1. PSU manufacturer name changed from SAMSUNG ELECTRO-MECHANICS CO., LTD. to SOLUM CO., LTD.
2. PSU safety logos changed from CQC (China Quality Certification) to CCC (China Compulsory Certificate) and, UL (Recognized Component Mark), BSMI (Bureau of Standards, Metrology and Inspection) and KCC (Korea Certification) updated to reflect SoluM's.
3. EAC (EurAsian Conformity Mark) logo added to PSU.
4. The PSU FRU Header updated its FW version (From 04A to 06A) to reflect this new Part Number and MFG Name changes. Therefore, if the PSU is read it will indicate SoluM as the MFG Name and Part Number #G36234-011 will be shown.

Please refer to the Products Affected table below for a summary of TA changes.

Figure 1. Before change



Figure 2. Post-change



Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
H2224XXKR2	943478	H70096-006	H70096-007

PCN Revision History:

Date of Revision:

November 25, 2016

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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